ASSOCIATION CONNECTI ELECTRONICS INDUSTRI	Material Comp © Copyright 2005. International and Pa	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard  Form Type http://www.ipc.org/IPC-175x  Form Type Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				erials and I	ials and Mfg Information				
upplier Inform	mation				·		·								
Company name*			Company unique ID			τ	Unique ID Authority				Respon	Response Date*			
nsemi										2025-0	2025-06-07				
Contact Name		Title - Contact			1	Phone - Contact*				Email	Email - Contact*				
Product-Env-Stew	vards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
uthorized Repres	sentative*	Title - Representative			1	Phone - Representative*				Email	Email - Representative*				
Product-Env-Stew	vards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
Reques	Requester Item Number Mi		Mfr Item Number Mfr Item Name				Effective Date	e Versio	on I	Manufacturing Site		Weight*	UOM	Unit Type	
		FQT7N1	QT7N10LTF QF 100V 350mOhm L SC		ım L SOT223		2025-06-07		]	KR3		118.973	mg	Each	
Ianufacturing	g Proccess Informa	tion						,	,						
Terminal Plating / Grid Array Material T			Cerminal Base Alloy J-STD-020 MSI		SL Rating	Peak Process Body Temperate				ature Numb	er of Reflow Cyc	eles			
Matte T	Cin (Sn) - annealed	(	CU Alloy	1			260		C	30	seco	onds 3			
omments															
vel 1 - maximum	time at peak temperat	ure during sol	dering is 10-3	30 seconds											
or more informat	tion regarding material	composition	please refer t	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to suc										
RoHS Declaration * 4 - Item(s	) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	astislav Drska	-En								

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.54	mg	Supplier	Silicon (Si)	7440-21-3		1.54	mg
Die Attach	0.541	mg	Supplier	Silver (Ag)	7440-22-4		0.0081	mg
			A	Lead (Pb)	7439-92-1	7a	0.5058	mg
			Supplier	Tin (Sn)	7440-31-5		0.0271	mg
Lead Frame	66.944	mg	Supplier	Silver (Ag)	7440-22-4		0.234	mg
			Supplier	Zinc (Zn)	7440-66-6		0.08	mg
			Supplier	Iron (Fe)	7439-89-6		1.61	mg
			Supplier	Copper (Cu)	7440-50-8		65	mg
			Supplier	Phosphorus (P)	7723-14-0		0.02	mg
Mold Compound-Black	41.108	mg	Supplier	2,2'-[(1-Methylethylidene)bis[(dibromo-4,1-phenylene)oxymethylene]]bis[oxirane]-4,4'-(1-methylethylidene)bis[2,6-dibromophenol] copolymer	68928-70-1		0.6166	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.8222	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2055	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		30.831	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		4.5219	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		3.2886	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.8222	mg
Plating	8.29	mg	Supplier	Tin (Sn)	7440-31-5		8.29	mg
Wire Bond - Au	0.55	mg	Supplier	Gold (Au)	7440-57-5		0.55	mg